

**SMD CRYSTAL UNIT SPECIFICATIONS**

|                          |                           |
|--------------------------|---------------------------|
| <b>Customer</b>          |                           |
| <b>Customer P/N</b>      |                           |
| <b>Product</b>           | 3225 Seam Sealing Crystal |
| <b>Nominal Frequency</b> | 10.000000MHz              |
| <b>HOSONIC P/N</b>       | E3SB10E000008E            |
| <b>Version</b>           | 10C0                      |
| <b>Issue Date</b>        | 2022/2/10                 |

| <b>HOSONIC</b> |                |                 |
|----------------|----------------|-----------------|
| <b>Drawn</b>   | <b>Checked</b> | <b>Approved</b> |
| <b>LUCY</b>    | <b>ZOE</b>     | <b>JOHN</b>     |

**Approved By Customer :** \_\_\_\_\_



**HOSONIC ELECTRONIC CO., LTD.**



Revised Record

| Rev. | Rev. Date  | Item | Content          | Remark |
|------|------------|------|------------------|--------|
| 1.0  | 2022-02-10 |      | Initial released |        |

**I ELECTRICAL PARAMETERS**

Electrical characteristics measured by S&amp;A250B or equivalent.

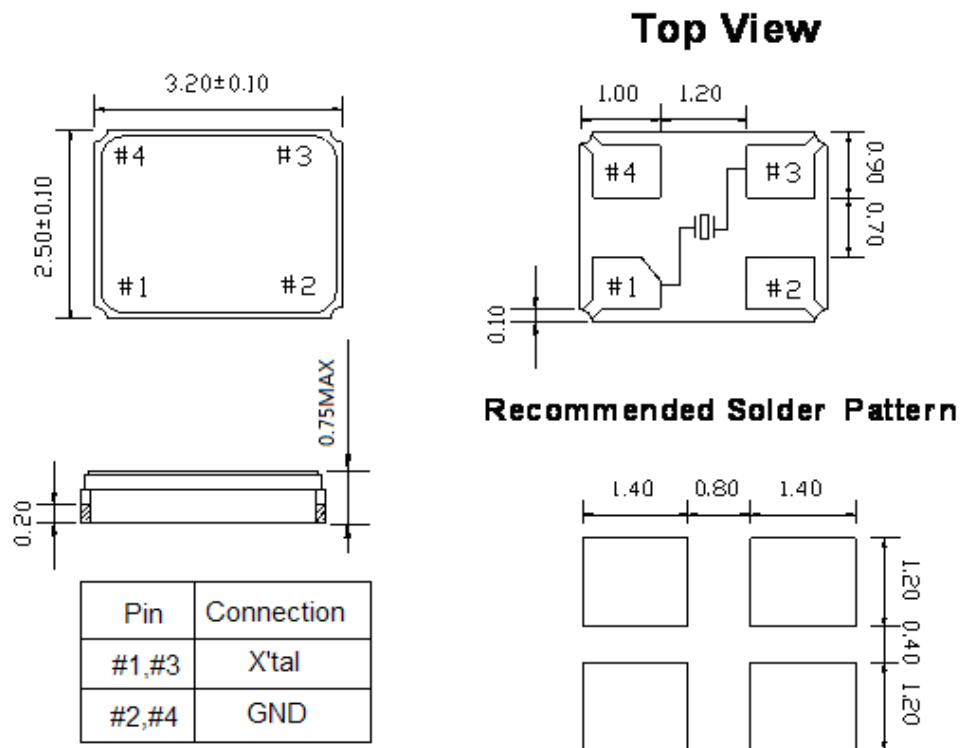
| No. | Item   | Symb.            | Electrical Specification |      |      |       | Remark                |  |
|-----|--|------------------|--------------------------|------|------|-------|-----------------------|--|
|     |  |                  | Min.                     | Typ. | Max. | Units |                       |  |
| 1   | Nominal Frequency                                | F0               | 10.000000                |      |      | MHz   |                       |  |
| 2   | Mode of Vibration                                |                  | Fundamental              |      |      |       |                       |  |
| 3   | Frequency Tolerance                              | $\Delta F/F0$    | -20                      | -    | 20   | ppm   | At 25°C±3°C           |  |
| 4   | Operating Temperature Range                      | T <sub>OPR</sub> | -40                      | -    | 85   | °C    |                       |  |
| 5   | Frequency Stability (over operating temperature) | TC               | -30                      | -    | 30   | ppm   | Ref. to 25°C          |  |
| 6   | Storage Temperature                              | T <sub>STG</sub> | -55                      | -    | 125  | °C    |                       |  |
| 7   | Load capacitance                                 | CL               | -                        | 16   | -    | pF    |                       |  |
| 8   | Equivalent Series Resistance                     | ESR              | -                        | -    | 150  | Ω     |                       |  |
| 9   | Drive Level                                      | DL               | -                        | 100  | 200  | μW    |                       |  |
| 10  | Insulation Resistance                            | IR               | 500                      | -    | -    | MΩ    | At 100V <sub>DC</sub> |  |
| 11  | Shunt Capacitance                                | C0               | -                        | -    | 3    | pF    |                       |  |
| 12  | Aging Per Year                                   | Fa               | -2                       | -    | 2    | ppm   | First Year            |  |
| 13  | Package type                                     | E3SB             |                          |      |      |       |                       |  |

**NOTE: Storage Temperature is only for the product itself, the temperature for the packing material is -4~40°C.**

**I STORAGE REQUIRMENT**

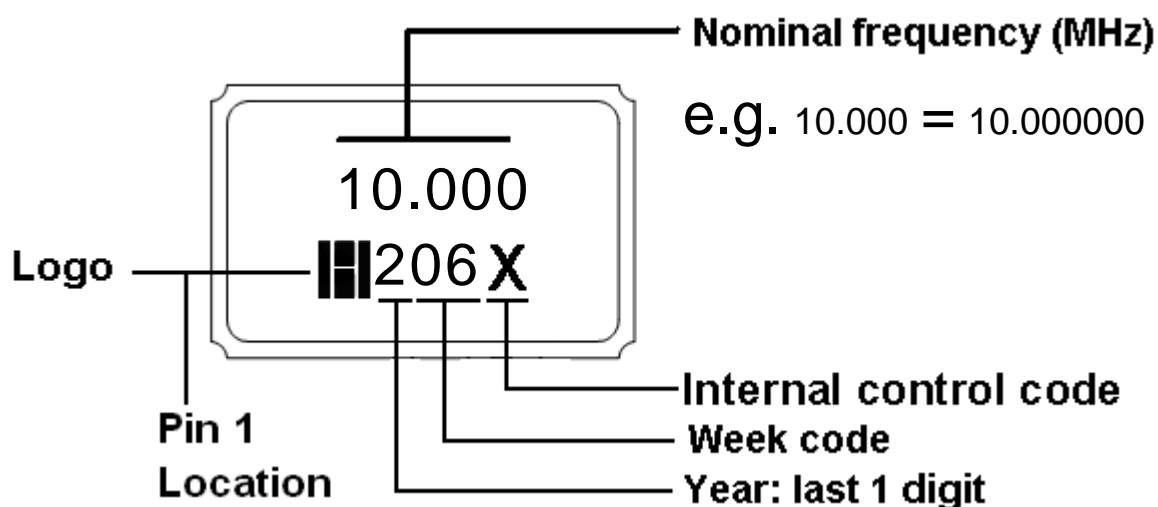
Storage environmental conditions: -4~40°C, 70%RH max.

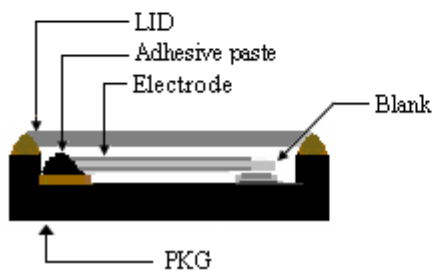
Maximum storage time: 24 Months from date of manufacture.

**I OUTLINE DIMENSIONS (UNIT: mm)**


**【Note】** #2, #4: connected with metal cover

\*unlabeled tolerance:  $\pm 0.1\text{mm}$

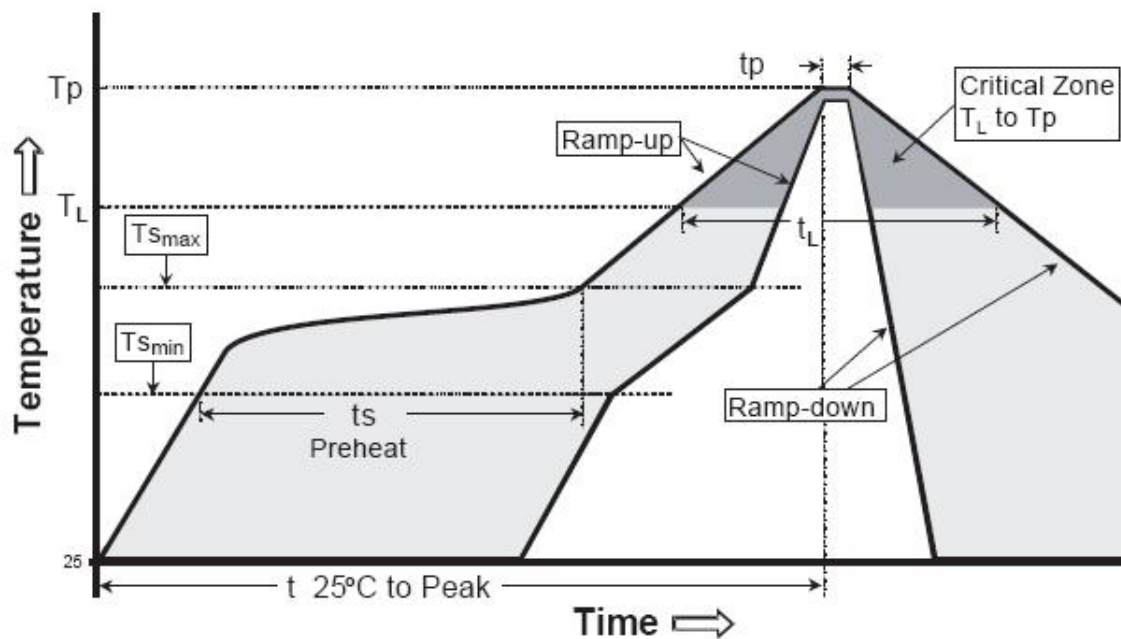
**I MARKING:**


**I PRODUCT LAYOUT**


| NO. | Part           | Material                       | Remark  |
|-----|----------------|--------------------------------|---------|
| 1   | LID            | KOVAR(Fe+Co+Ni alloy)          |         |
| 2   | PKG            | Al <sub>2</sub> O <sub>3</sub> | Base    |
| 3   | Blank          | SiO <sub>2</sub>               | Quartz  |
| 4   | Adhesive paste | Ag/Silicon                     | Support |
| 5   | Electrode      | Noble metal                    |         |

**I REFLOW PROFILES**

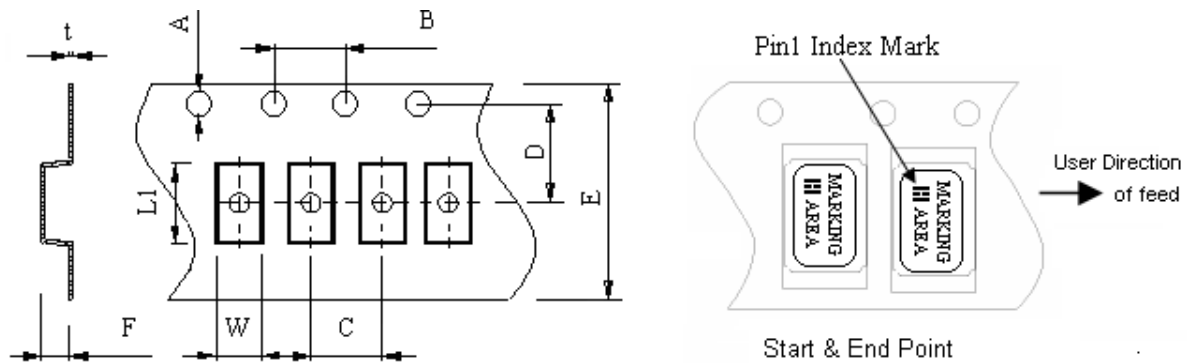
| Profiles Feature  | Pb-Free Assembly                 |
|---|----------------------------------|
| Average Ramp-up Rate (Ts max to Tp)   | 3°C/second max.                  |
| Preheat <ul style="list-style-type: none"> <li>■ Temperature Min (Ts min)</li> <li>■ Temperature Max (Ts max)</li> <li>■ Time (ts min to ts max)</li> </ul> | 125°C<br>200°C<br>60~180 seconds |
| Time maintained above <ul style="list-style-type: none"> <li>■ Temperature (T<sub>L</sub>)</li> <li>■ Time (t<sub>L</sub>)</li> </ul>                       | 217°C<br>60~150 seconds          |
| Peak/Classification Temperature (Tp)  | 260°C                            |
| Time within 5°C of actual Peak Temperature (t <sub>p</sub> )  | 20~40 seconds                    |
| Ramp-down rate  | 6°C/second max.                  |
| Time 25°C to Peak Temperature   | 8 minutes max.                   |
| <b>Suggest reflow times</b>   | <b>3 Times max</b>               |



**Remark: To reference JEDEC J-STD-020**

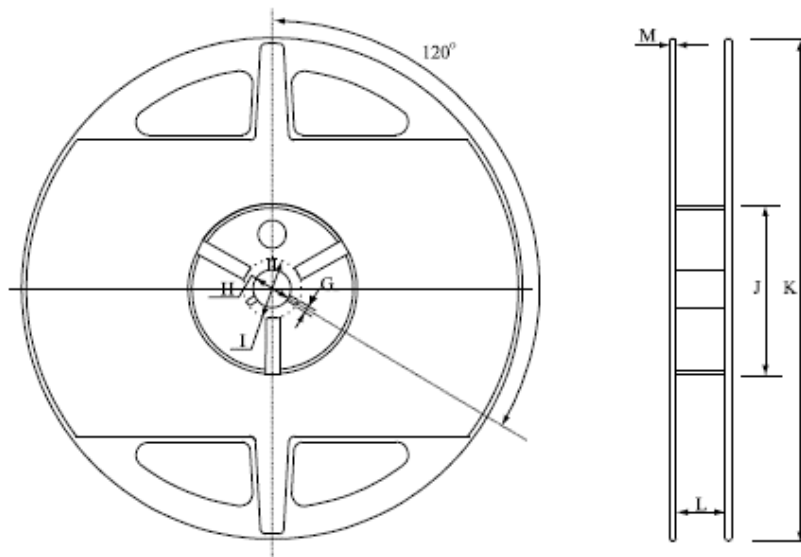
**I PACKAGE(reference to EIA-481)**

*Tape Dimensions(unit : mm)*



| A       | B       | C       | D       | E       | F       | L1      | W       | t         |
|---------|---------|---------|---------|---------|---------|---------|---------|-----------|
| 1.5±0.1 | 4.0±0.1 | 4.0±0.1 | 3.5±0.1 | 8.0±0.1 | 0.8±0.1 | 3.4±0.1 | 2.7±0.1 | 0.25±0.05 |

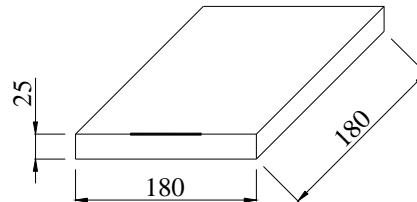
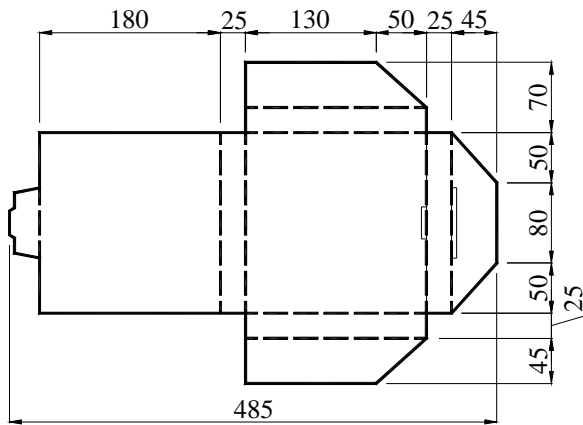
*Reel Dimensions(unit: mm)*



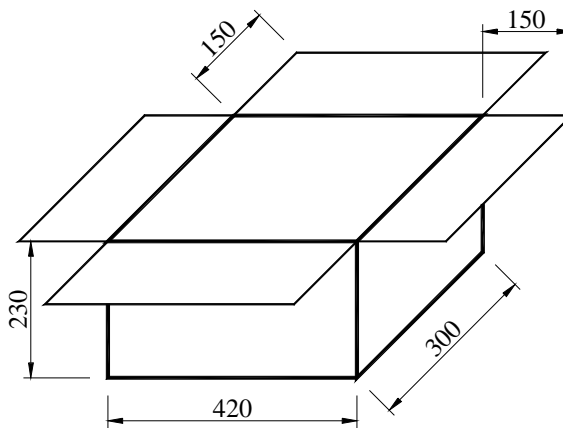
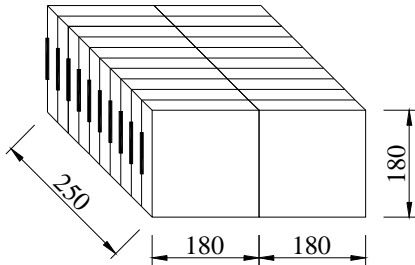
| G       | H        | I        | J        | K         | L       | M       |
|---------|----------|----------|----------|-----------|---------|---------|
| 2.2±0.5 | 13.5±0.5 | 18.2±0.5 | 60.0±1.0 | 178.0±1.0 | 9.5±1.0 | 1.6±0.2 |

\*3000pcs/Reel

Carton Dimension (unit : mm)



1 reel = 1 Inner box



20 Inner boxes = 1 Carton

60kpcs = 1 Carton



**I RELIABILITY SPECIFICATIONS**

| No. | Test Item                               | Test Conditions  | Reference                 |
|-----|---|--|---------------------------|
| 1   | High Temperature Storage                | Temperature: $125^{\circ}\text{C} \pm 3^{\circ}\text{C}$<br>Time: $1000 \pm 12$ Hours  | MIL-STD-202<br>Method 108 |
| 2   | Temperature Cycle                       | Temperature 1: $-55^{\circ}\text{C} \pm 3^{\circ}\text{C}$<br>Temperature 2: $125^{\circ}\text{C} \pm 3^{\circ}\text{C}$<br>Temperature change between T1 and T2 at soonest<br>Run 1000 cycles, maintain T1 and T2 5minutes each in one cycle  | JESD22 Method JA-104      |
| 3   | Solder Heat Resistance                  | Pre-heat: $125^{\circ}\text{C}$ 60~120 Seconds<br>Solder Temperature: $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$<br>Time: 30 Seconds  | MIL-STD-202<br>Method 210 |
| 4   | Drop Test                               | 3 Times Free Fall from 150cm height to concrete floor.   | IEC 68-2-32               |
| 5   | High Temperature, High Humidity Storage | Temperature: $85^{\circ}\text{C} \pm 5^{\circ}\text{C}$<br>Relative Humidity: 80%--85%<br>Time: 250Hours $\pm 12$ Hours  | MIL-STD-202<br>Method 103 |
| 6   | Steam Aging                             | Temperature: $97^{\circ}\text{C} \pm 3^{\circ}\text{C}$<br>Time: 24 Hours<br>$260^{\circ}\text{C}$ solder pot to check solderability   | J-STD-002                 |
| 7   | Solderability                           | Dip in flux 5~10 seconds<br>Temperature: $245^{\circ}\text{C} \pm 5^{\circ}\text{C}$<br>Time: 10 Seconds   | J-STD-002                 |
| 8   | Aging                                   | Temperature: $85^{\circ}\text{C} \pm 2^{\circ}\text{C}$<br>Time: $250 \pm 12$ Hours  | MIL-STD-202<br>Method 108 |
| 9   | Thermal Shock                           | Temperature 1: $-55^{\circ}\text{C} \pm 3^{\circ}\text{C}$<br>Temperature 2: $125^{\circ}\text{C} \pm 3^{\circ}\text{C}$<br>Temperature change between T1 and T2: 5 seconds<br>100 cycles, maintain T1 and T2 for 30 minutes each in one cycle | MIL-STD-202<br>Method 107 |
| 10  | Vibration                               | Frequency Range: 10Hz~2000Hz<br>Amplitude: 1.5mm or 20G<br>4Hours in each direction, total 12Hours   | MIL-STD-202<br>Method 204 |